



3-TERMINAL POSITIVE VOLTAGE REGULATOR

LM7808



TO-220 Leaded Plastic Package RoHS compliant

TO-220

GENERAL DESCRIPTION:

The Voltages available allow these Regulators to be used in Logic Systems, Instrumentation, Hi-Fi Audio Circuits and other Solid State Electronic Equipment

FEATURES:

1. This product is available in AEC-Q101 Compliant and PPAP Capable also. Note: For AEC-Q101 compliant products, please use suffix -AQ in the part number while ordering.

APPLICATION:

Industrial Power Supplies, SMPS Post Regulation, HVAC Systems ,AC Inventors ,Test and Measurement Equipment,Brushed and Brush less DC Motor Drivers,Solar Energy String Inverters

ABSOLUTE MAXIMUM RATINGS (Ta = 25 °C Unless otherwise specified)

PARAMETER	SYMBOL	VALUE	UNIT
Input Voltage	V _{IN}	35	V
Power Dissipation at T _a =25°C	P _D	2	W
Power Dissipation at T _c =25°C	P _D	15	W
Operating Free Air, Case, or Virtual	TJ	0 to 150	°C
Storage Temperature Range	T _{stg}	-65 to +150	°C
Lead Temperature 1.6mm (1/16 inch) from Case for 10 seconds	TL	260	°C

Recommended Operating Conditions

DADAMETED	SAMBOI	VALUE			
		MIN	TYP	MAX	UNIT
Input Voltage	V	10.0		25	V
Output Current	Ι _ο	1		1.5	А
Operating Junction Temperature	Т _ј	0		125	°C



ELECTRICAL CHARACTERISTICS at (Ta = 25 °C Unless otherwise specified)

V_{IN}=14V, I_O=500mA, T_a=25°C

DADAMETED		VALUE				
PARAMETER	STWIDUL	TEST CONDITION	MIN	TYP	MAX	UNIT
		25°C	7.7		8.3	V
Output Voltage	Vo	I _O =5mA ~ 1A V _{IN} =10.5 ~ 23V, P _D <15W, 0°C ~125°C	7.6		8.4	V
Line Regulation	5	V _{IN} =10.5 ~ 25V, 25°C			160	mV
	NEGV	V _{IN} =11 ~ 17V, 25°C			80	mV
Ripple Rejection	R _R	V _{IN} =11.5 ~ 21.5V, f=120Hz, 0°C~125°C	55		-	dB
Lood Dogulation	R _{EGL}	I ₀ =5mA ∼ 1.5A , 25ºC			160	mV
Load Regulation		I _o =250mA ∼ 750mA , 25ºC			80	mV
Output Resistance	rO	f=1KHz, 0°C~125°C		0.016	-	Ω
Temperature Coefficient of Output Voltage	$\Delta V_{O} / \Delta T$	I ₀ =5mA, 0⁰C∼25⁰C		-0.8		mV/°C
Output Noise Voltage	V _{NO}	f=10Hz ~100KHz, 25°C		52		μV
Dropout Voltage	V _{DIF (min)}	I ₀ =1A , 25⁰C		2.0		V
Quiescent Current	ا _م	25°C			8.0	mA
Quiescent Current Change	ΔI_{QIN}	V _{IN} =10.5 ~ 25V, 0°C~150°C			1.0	mA
		I ₀ =5mA ~ 1A, 0°C~150°C			0.5	mA
Short Circuit Output Current	I _{sc}	25°C		450		mA
Peak Output Current	I _{omax}	25°C		2.2		Α





Recommended Reflow Solder Profiles

The recommended reflow solder profiles for Pb and Pb-free devices are shown below.

Figure 1 shows the recommended solder profile for devices that have Pb-free terminal plating, and where a Pb-free solder is used.

Figure 2 shows the recommended solder profile for devices with Pb-free terminal plating used with leaded solder, or for devices with leaded terminal plating used with a leaded solder.





Figure 2

TIME (SEC)

Reflow profiles in tabular form

Profile Feature	Sn-Pb System	Pb-Free System
Average Ramp-Up Rate	~3°C/second	~3°C/second
Preheat		
 Temperature Range 	150-170°C	150-200°C
– Time	60-180 seconds	60-180 seconds
Time maintained above:		
– Temperature	200°C	217°C
– Time	30-50 seconds	60-150 seconds
Peak Temperature	235°C	260°C max.
Time within +0 -5°C of actual Peak	10 seconds	40 seconds
Ramp-Down Rate	3°C/second max.	6°C/second max.





Recommended Wave Solder Profiles

The Recommended solder Profile For Devices with Pb-free terminal plating where a Pb-free solder is used





The Recommended solder Profile For Devices

with Pb-free terminal plating used with leaded

solder, or for devices with leaded terminal

Wave Profiles in Tabular Form

Profile Feature	Sn-Pb System	Pb-Free System	
Average Ramp-Up Rate	~200°C/second	~200°C/second	
Heating rate during preheat	Typical 1-2, Max 4°C/sec	Typical 1-2, Max 4°C/Sec	
Final preheat Temperature	Within 125°C of Solder Temp	Within 125°C of Solder Temp	
Peak Temperature	235°C	260°C max.	
Time within +0 -5°C of actual Peak	10 seconds	10 seconds	
Ramp-Down Rate	5°C/second max.	5°C/second max	



PACKAGE DETAILS

TO-220 Leaded Plastic Package



DIM	MIN	TYP	MAX
А			10.7
В			1.4
С			4.8
D			6.9
Е			16.5
F	12.5		
G		3.81	
H			0.4
J		2.67	
К		2.51	
L			1.2
М		1.27	

All Dimensions are in mm

PIN CONFIGURATION

- 1. Input
- 2. Ground
- 3. Output





Recommended Product Storage Environment for Discrete Semiconductor Devices

This storage environment assumes that the Diodes and transistors are packed properly inside the original packing supplied by CDIL.

- · Temperature 5 °C to 30 °C
- · Humidity between 40 to 70 %RH
- $\cdot\,$ Air should be clean.
- · Avoid harmful gas or dust.
- \cdot Avoid outdoor exposure or storage in areas subject to rain or water spraying .
- Avoid storage in areas subject to corrosive gas or dust. Product shall not be stored in areas exposed to direct sunlight.
- · Avoid rapid change of temperature.
- · Avoid condensation.
- $\cdot\,$ Mechanical stress such as vibration and impact shall be avoided.
- · The product shall not be placed directly on the floor.
- The product shall be stored on a plane area. They should not be turned upside down. They should not be placed against the wall.

Shelf Life of CDIL Products

The shelf life of products is the period from product manufacture to shipment to customers. The product can be unconditionally shipped within this period. The period is defined as 2 years.

If products are stored longer than the shelf life of 2 years the products shall be subjected to quality check as per CDIL quality procedure.

The products are further warranted for another one year after the date of shipment subject to the above conditions in CDIL original packing.

Floor Life of CDIL Products and MSL Level

When the products are opened from the original packing, the floor life will start. For this, the following JEDEC table may be referred:

JEDEC MSL Level			
Level	Time	Condition	
1	Unlimited	≤30 °C / 85% RH	
2	1 Year	≤30 °C / 60% RH	
2a	4 Weeks	≤30 °C / 60% RH	
3	168 Hours	≤30 °C / 60% RH	
4	72 Hours	≤30 °C / 60% RH	
5	48 Hours	≤30 °C / 60% RH	
5a	24 Hours	≤30 °C / 60% RH	
6	Time on Label(TOL)	≤30 °C / 60% RH	





Customer Notes

Component Disposal Instructions

- 1. CDIL Semiconductor Devices are RoHS compliant, customers are requested to please dispose as per prevailing Environmental Legislation of their Country.
- 2. In Europe, please dispose as per EU Directive 2002/96/EC on Waste Electrical and Electronic Equipment (WEEE).

Disclaimer

The product information and the selection guides facilitate selection of the CDIL's Semiconductor Device(s) best suited for application in your product(s) as per your requirement. It is recommended that you completely review our Data Sheet(s) so as to confirm that the Device(s) meet functionality parameters for your application. The information furnished in the Data Sheet and on the CDIL Web Site/CD are believed to be accurate and reliable. CDIL however, does not assume responsibility for inaccuracies or incomplete information. Furthermore, CDIL does not assume liability whatsoever, arising out of the application or use of any CDIL product; neither does it convey any license under its patent rights nor rights of others. These products are not designed for use in life saving /support appliances or systems. CDIL customers selling these products (either as individual Semiconductor Devices or incorporated in their end products), in any life saving/support appliances or systems or applications do so at their own risk and CDIL will not be responsible for any damages resulting from such sale(s).

CDIL strives for continuous improvement and reserves the right to change the specifications of its products without prior notice.



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